MBT3904DW1T1, MBT3904DW2T1

Dual General Purpose Transistors

The MBT3904DW1T1 and MBT3904DW2T1 devices are a spin−off of our popular SOT−23/SOT−323 three−leaded device. It is designed for general purpose amplifier applications and is housed in the SOT−363 six−leaded surface mount package. By putting two discrete devices in one package, this device is ideal for low−power surface mount applications where board space is at a premium.

Features

- h_{FE}, 100−300
- Low $V_{CE(sat)}$, ≤ 0.4 V
- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- Available in 8 mm, 7−inch/3,000 Unit Tape and Reel
- Pb−Free Packages are Available

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V_{CEO}	40	Vdc
Collector–Base Voltage	V_{CBO}	60	Vdc
Emitter–Base Voltage	V_{EBO}	6.0	Vdc
Collector Current – Continuous	I_C	200	mAdc
Electrostatic Discharge	ESD	HBM>16000, MM>2000	V

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

THERAML CHARACTERISTICS

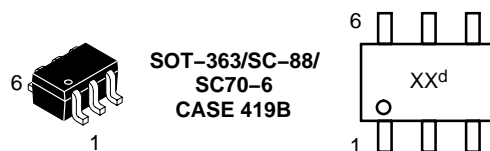| Characteristic	Symbol	Max	Unit
Total Package Dissipation (Note 1) $T_A = 25°C$	P_D	150	mW
Thermal Resistance, Junction–to–Ambient	$R_{\theta JA}$	833	°C/W
Junction and Storage Temperature Range	T_J, T_{stg}	−55 to +150	°C

1. Device mounted on FR4 glass epoxy printed circuit board using the minimum recommended footprint.

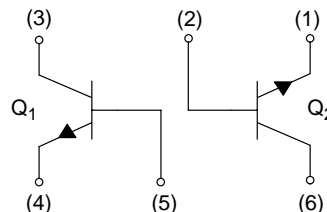**ON Semiconductor®**

http://onsemi.com
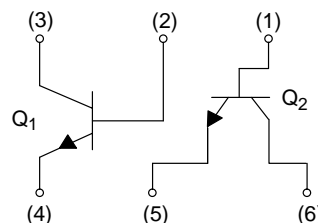
MARKING DIAGRAM

SOT−363/SC−88/ SC70−6 CASE 419B

XX = MA for MBT3904DW1T1
MJ for MBT3904DW2T1
d = Date Code

MBT3904DW1T1 STYLE 1

MBT3904DW2T1 STYLE 27

ORDERING INFORMATION

Device	Package	Shipping[†]
MBT3904DW1T1	SOT−363	3000 Units/Reel
MBT3904DW1T1G	SOT−363 (Pb−Free)	3000 Units/Reel
MBT3904DW2T1	SOT−363	3000 Units/Reel
MBT3904DW2T1G	SOT−363 (Pb−Free)	3000 Units/Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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**ELECTRICAL CHARACTERISTICS** (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector – Emitter Breakdown Voltage (Note 2) (I_C = 1.0 mAdc, I_B = 0)	$V_{(BR)CEO}$	40	–	Vdc
Collector – Base Breakdown Voltage (I_C = 10 μAdc, I_E = 0)	$V_{(BR)CBO}$	60	–	Vdc
Emitter – Base Breakdown Voltage (I_E = 10 μAdc, I_C = 0)	$V_{(BR)EBO}$	6.0	–	Vdc
Base Cutoff Current (V_{CE} = 30 Vdc, V_{EB} = 3.0 Vdc)	I_{BL}	–	50	nAdc
Collector Cutoff Current (V_{CE} = 30 Vdc, V_{EB} = 3.0 Vdc)	I_{CEX}	–	50	nAdc
ON CHARACTERISTICS (Note 2)				
DC Current Gain (I_C = 0.1 mAdc, V_{CE} = 1.0 Vdc) (I_C = 1.0 mAdc, V_{CE} = 1.0 Vdc) (I_C = 10 mAdc, V_{CE} = 1.0 Vdc) (I_C = 50 mAdc, V_{CE} = 1.0 Vdc) (I_C = 100 mAdc, V_{CE} = 1.0 Vdc)	h_{FE}	40 70 100 60 30	– – 300 – –	–
Collector – Emitter Saturation Voltage (I_C = 10 mAdc, I_B = 1.0 mAdc) (I_C = 50 mAdc, I_B = 5.0 mAdc)	$V_{CE(sat)}$	– –	0.2 0.3	Vdc
Base – Emitter Saturation Voltage (I_C = 10 mAdc, I_B = 1.0 mAdc) (I_C = 50 mAdc, I_B = 5.0 mAdc)	$V_{BE(sat)}$	0.65 –	0.85 0.95	Vdc
SMALL–SIGNAL CHARACTERISTICS				
Current – Gain – Bandwidth Product (I_C = 10 mAdc, V_{CE} = 20 Vdc, f = 100 MHz)	f_T	300	–	MHz
Output Capacitance (V_{CB} = 5.0 Vdc, I_E = 0, f = 1.0 MHz)	C_{obo}	–	4.0	pF
Input Capacitance (V_{EB} = 0.5 Vdc, I_C = 0, f = 1.0 MHz)	C_{ibo}	–	8.0	pF
Input Impedance (V_{CE} = 10 Vdc, I_C = 1.0 mAdc, f = 1.0 kHz)	h_{ie}	1.0 2.0	10 12	k Ω
Voltage Feedback Ratio (V_{CE} = 10 Vdc, I_C = 1.0 mAdc, f = 1.0 kHz)	h_{re}	0.5 0.1	8.0 10	X 10^{-4}
Small – Signal Current Gain (V_{CE} = 10 Vdc, I_C = 1.0 mAdc, f = 1.0 kHz)	h_{fe}	100 100	400 400	–
Output Admittance (V_{CE} = 10 Vdc, I_C = 1.0 mAdc, f = 1.0 kHz)	h_{oe}	1.0 3.0	40 60	μmhos
Noise Figure (V_{CE} = 5.0 Vdc, I_C = 100 μAdc, R_S = 1.0 k Ω, f = 1.0 kHz)	NF	– –	5.0 4.0	dB

2. Pulse Test: Pulse Width ≤ 300 μs; Duty Cycle ≤ 2.0%.

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SWITCHING CHARACTERISTICS

Characteristic		Symbol	Min	Max	Unit
Delay Time	(V_{CC} = 3.0 Vdc, V_{BE} = −0.5 Vdc)	t_d	–	35	ns
Rise Time	(I_C = 10 mAdc, I_{B1} = 1.0 mAdc)	t_r	–	35	
Storage Time	(V_{CC} = 3.0 Vdc, I_C = 10 mAdc)	t_s	–	200	ns
Fall Time	(I_{B1} = I_{B2} = 1.0 mAdc)	t_f	–	50	

* Total shunt capacitance of test jig and connectors
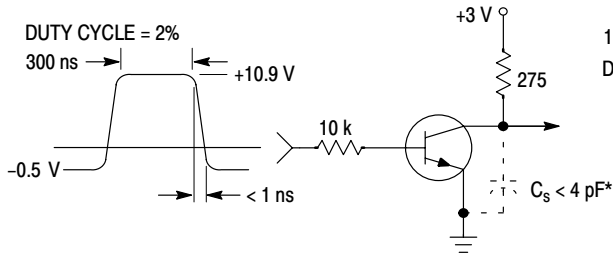
**Figure 1. Delay and Rise Time
Equivalent Test Circuit**
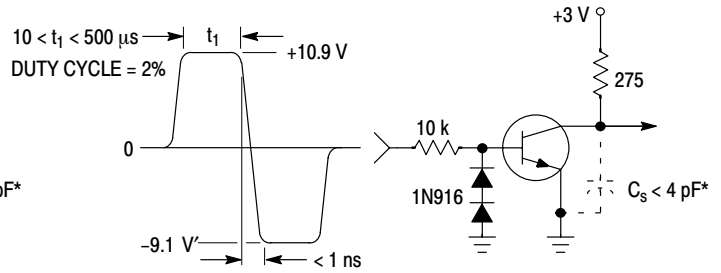
**Figure 2. Storage and Fall Time
Equivalent Test Circuit**

MBT3904DW1T1, MBT3904DW2T1

TYPICAL TRANSIENT CHARACTERISTICS

$T_J = 25°C$
$T_J = 125°C$
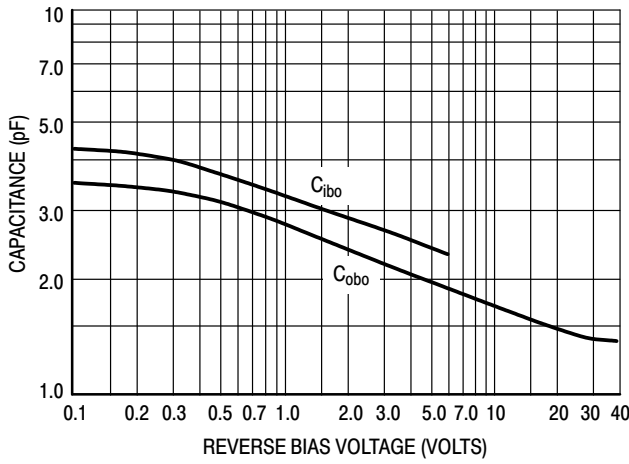
Figure 3. Capacitance
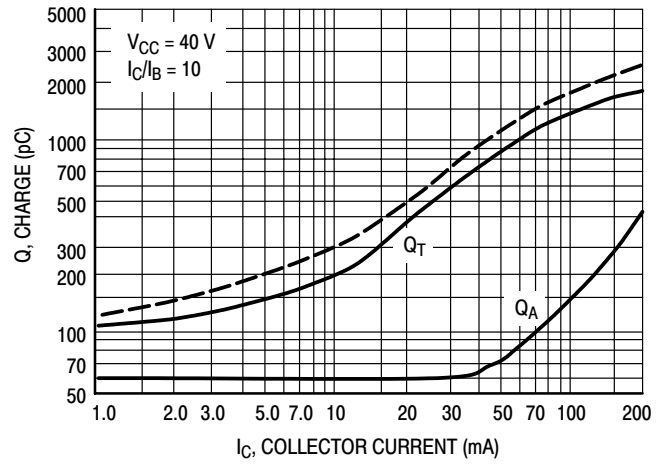
Figure 4. Charge Data
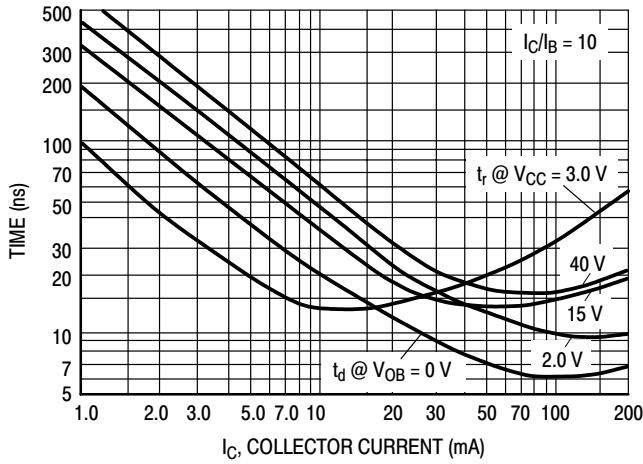
Figure 5. Turn–On Time
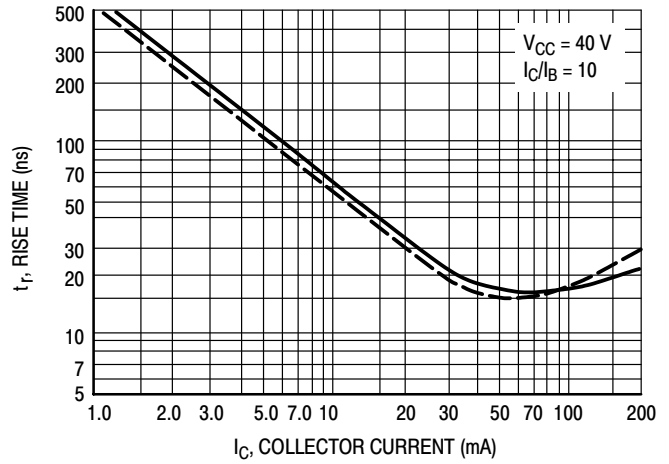
Figure 6. Rise Time
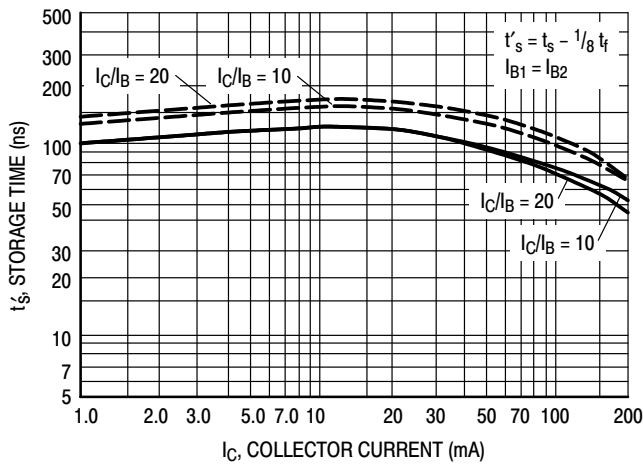
Figure 7. Storage Time
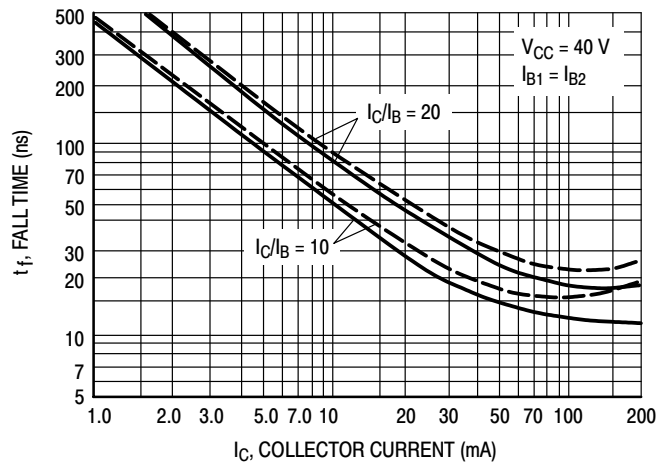
Figure 8. Fall Time

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TYPICAL AUDIO SMALL−SIGNAL CHARACTERISTICS
NOISE FIGURE VARIATIONS
(V_{CE} = 5.0 Vdc, T_A = 25°C, Bandwidth = 1.0 Hz)
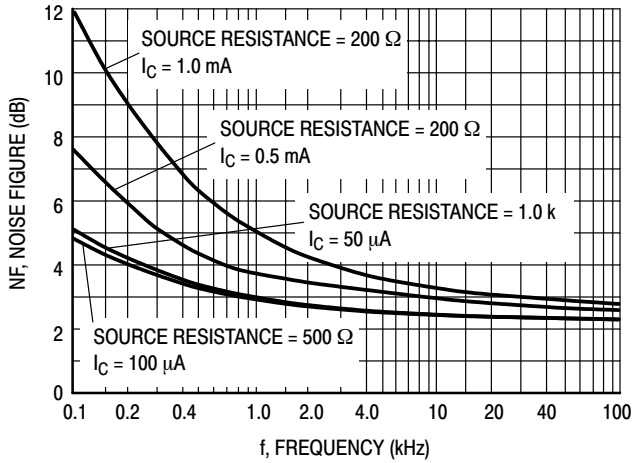
Figure 9. Noise Figure
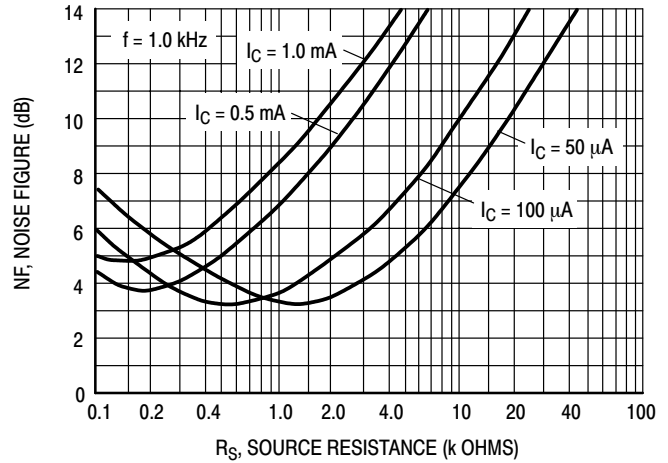
Figure 10. Noise Figure

h PARAMETERS
(V_{CE} = 10 Vdc, f = 1.0 kHz, T_A = 25°C)
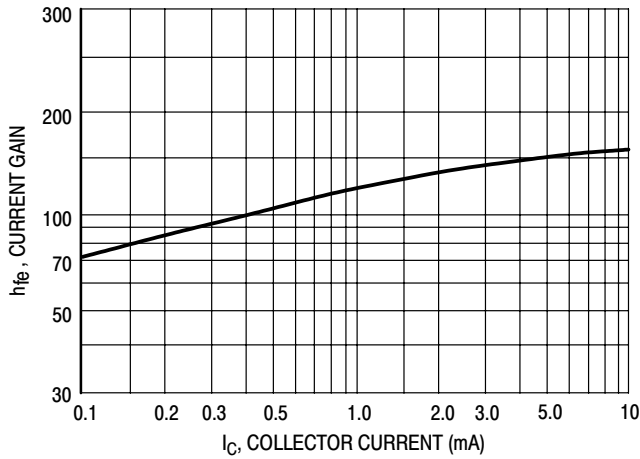
Figure 11. Current Gain
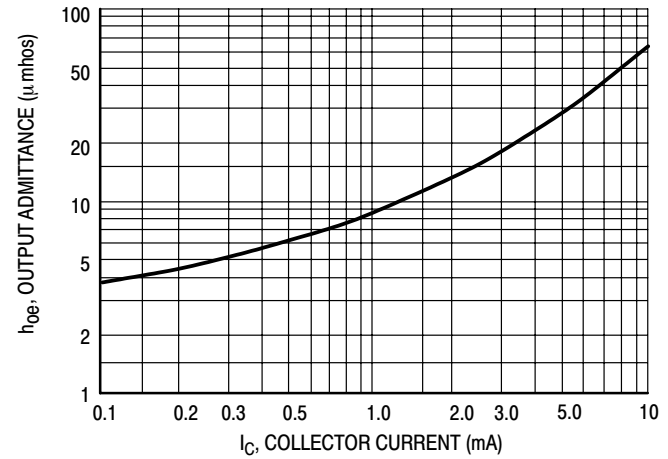
Figure 12. Output Admittance
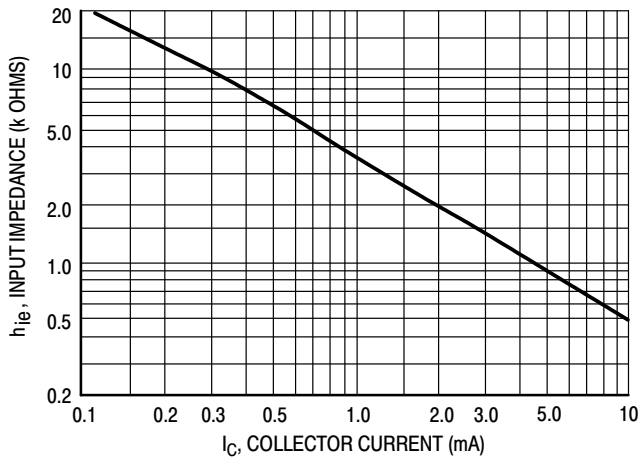
Figure 13. Input Impedance
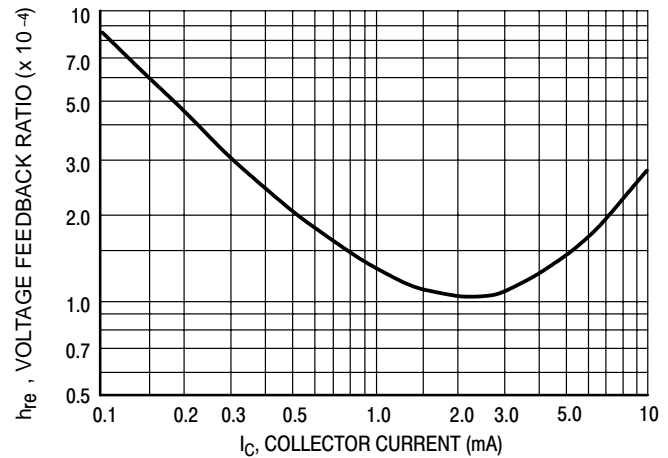
Figure 14. Voltage Feedback Ratio

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TYPICAL STATIC CHARACTERISTICS
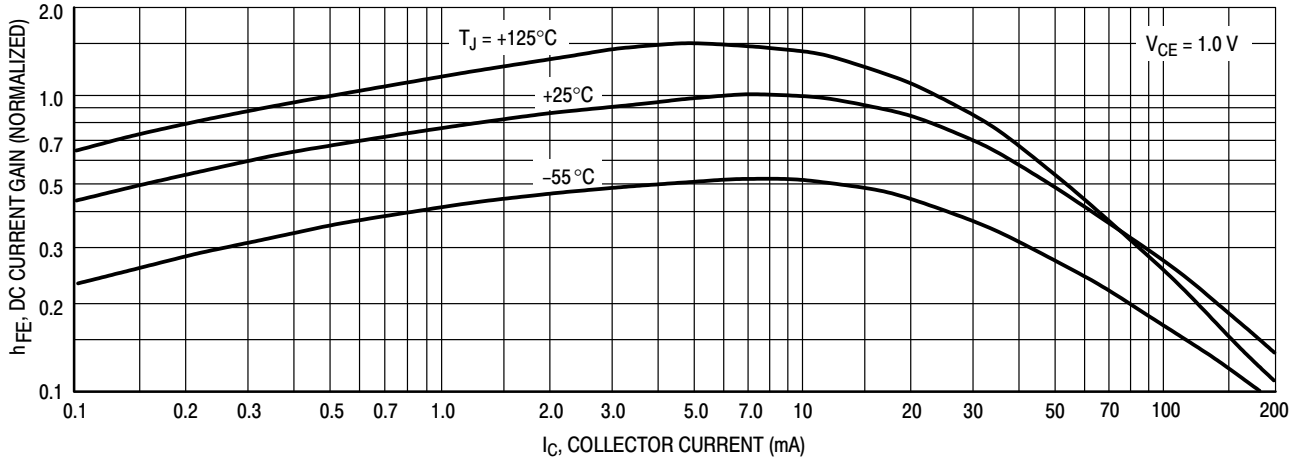
Figure 15. DC Current Gain
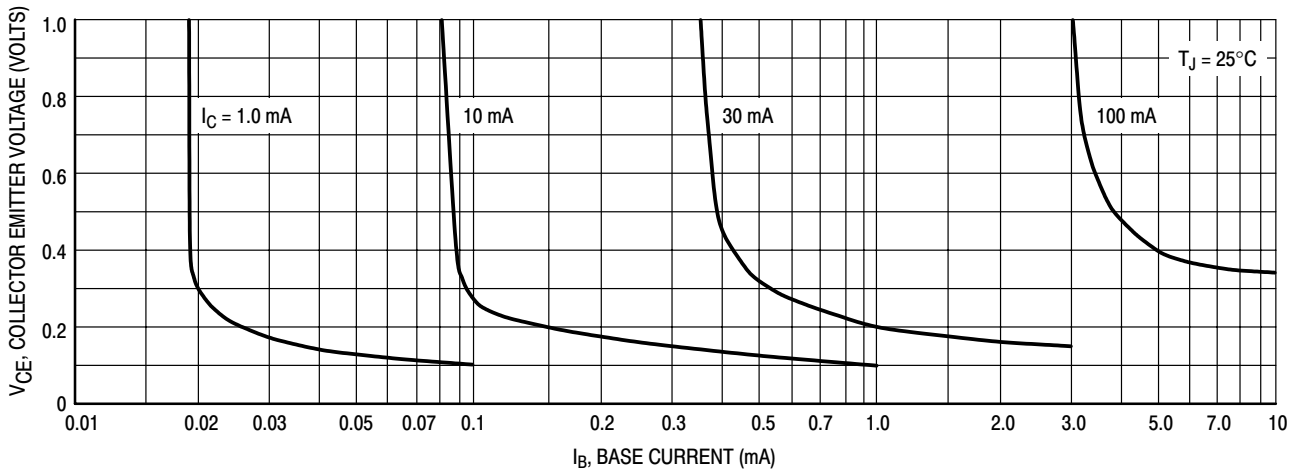
Figure 16. Collector Saturation Region
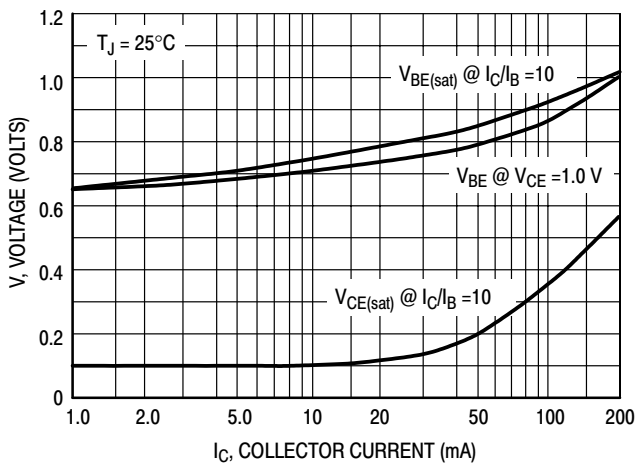
Figure 17. "ON" Voltages
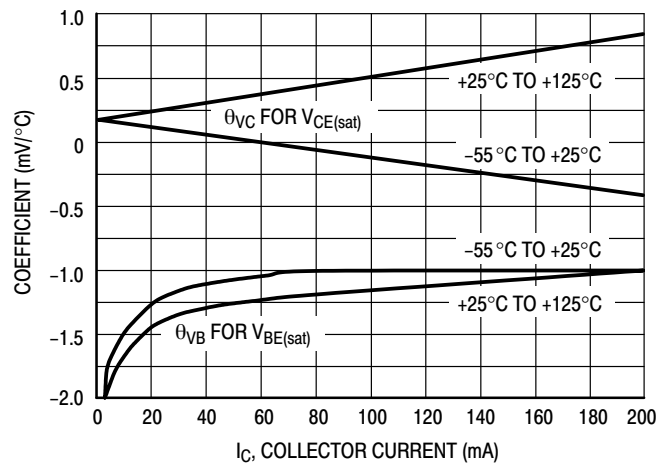
Figure 18. Temperature Coefficients

PACKAGE DIMENSIONS

SOT–363/SC–88/SC70–6
CASE 419B–02
ISSUE U
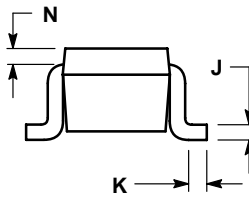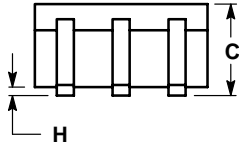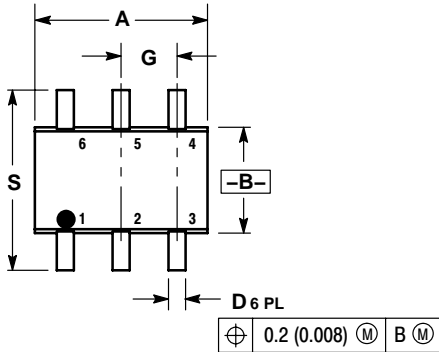
NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. 419B–01 OBSOLETE, NEW STANDARD 419B–02.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.071	0.087	1.80	2.20
B	0.045	0.053	1.15	1.35
C	0.031	0.043	0.80	1.10
D	0.004	0.012	0.10	0.30
G	0.026 BSC		0.65 BSC	
H	–––	0.004	–––	0.10
J	0.004	0.010	0.10	0.25
K	0.004	0.012	0.10	0.30
N	0.008 REF		0.20 REF	
S	0.079	0.087	2.00	2.20

STYLE 1:
PIN 1. EMITTER 2
    2. BASE 2
    3. COLLECTOR 1
    4. EMITTER 1
    5. BASE 1
    6. COLLECTOR 2

STYLE 27:
PIN 1. BASE 2
    2. BASE 1
    3. COLLECTOR 1
    4. EMITTER 1
    5. EMITTER 2
    6. COLLECTOR 2

⊕ | 0.2 (0.008) Ⓜ | B Ⓜ

SOLDERING FOOTPRINT*

$\frac{0.50}{0.0197}$

$\frac{0.65}{0.025}$

$\frac{0.65}{0.025}$

$\frac{0.40}{0.0157}$

$\frac{1.9}{0.0748}$

SCALE 20:1 $\left(\frac{mm}{inches}\right)$
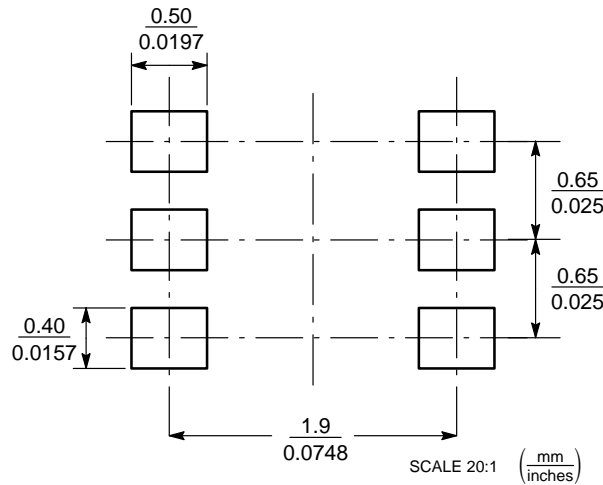
*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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